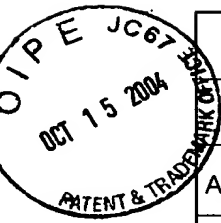


41

2621



AMENDMENT TRANSMITTAL LETTER

Docket No.  
M4065.0215/P215

Application No.  
09/516,581-Conf. #3124

Filing Date  
March 1, 2000

Examiner  
B. P. Werner

Art Unit  
2621

Applicant(s): Eugene A. DeLaRosa et al.

Invention: METHOD FOR MEASURING REGISTRATION OF OVERLAPPING MATERIAL LAYERS OF AN INTEGRATED CIRCUIT

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TO THE COMMISSIONER FOR PATENTS

Transmitted herewith is an amendment in the above-identified application.  
The fee has been calculated and is transmitted as shown below.

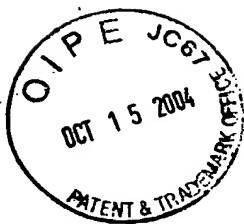
CLAIMS AS AMENDED					
	Claims Remaining After Amendment	Highest Number Previously Paid	Number Extra Claims Present	Rate	
Total Claims	39	- 39 =		x	0.00
Independent Claims	3	- 3 =		x	0.00
Multiple Dependent Claims (check if applicable) <input type="checkbox"/>					
Other fee (please specify):					
TOTAL ADDITIONAL FEE FOR THIS AMENDMENT:					0.00

- ☒ Large Entity ☐ Small Entity
- ☒ No additional fee is required for this amendment.
- ☐ Please charge Deposit Account No. \_\_\_\_\_ in the amount of \$ \_\_\_\_\_.  
A duplicate copy of this sheet is enclosed.
- ☐ A check in the amount of \$ \_\_\_\_\_ to cover the filing fee is enclosed.
- ☐ Payment by credit card. Form PTO-2038 is attached.
- ☒ The Director is hereby authorized to charge and credit Deposit Account No. 04-1073  
as described below. A duplicate copy of this sheet is enclosed.
- ☒ Credit any overpayment.
- ☒ Charge any additional filing or application processing fees required under 37 CFR 1.16 and 1.17.

Thomas J. D'Amico  
Attorney Reg. No.: 28,371

Dated: October 15, 2004

DICKSTEIN SHAPIRO MORIN & OSHINSKY LLP  
2101 L Street NW  
Washington, DC 20037-1526  
(202) 828-2232



Docket No.: M4065.0215/P215  
(PATENT)

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Patent Application of:  
Eugene A. DeLaRosa et al.

Confirmation No.: 3124

Application No.: 09/516,581

Art Unit: 2621

Filed: March 1, 2000

Examiner: B. P. Werner

For: METHOD FOR MEASURING  
REGISTRATION OF OVERLAPPING  
MATERIAL LAYERS OF AN INTEGRATED  
CIRCUIT

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**AMENDMENT IN RESPONSE TO NON-FINAL OFFICE ACTION**

MS Amendment  
Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

Dear Sir:

**INTRODUCTORY COMMENTS**

In response to the Office Action dated July 15, 2004 (Paper No. Mail Date 12), please reconsider the above-identified U.S. patent application as follows:

**Amendments to the claims** are reflected in the listing of claims which begins on page 2 of this paper.

**Remarks** begin on page 9 of this paper.